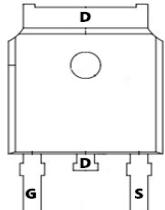
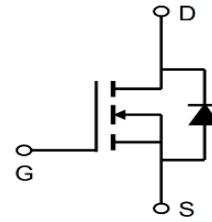
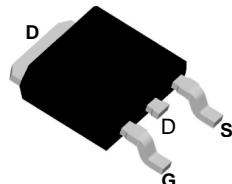


# TM60N06AD

## N-Channel Enhancement Mosfet

<b>General Description</b> <ul style="list-style-type: none"> <li>Low <math>R_{DS(ON)}</math></li> <li>RoHS and Halogen-Free Compliant</li> </ul> <b>Applications</b> <ul style="list-style-type: none"> <li>Load switch</li> <li>PWM</li> </ul>	<b>General Features</b> <p> <math>V_{DS} = 60V</math> <math>I_D = 58A</math>  <math>R_{DS(ON)} = 9.8\text{ m}\Omega</math> (typ.) @ <math>V_{GS} = 10V</math>          100% UIS Tested          100% <math>R_g</math> Tested       </p> 
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**D:TO-252-3 L**


Marking: 60N06A

### Absolute Maximum Ratings ( $T_A = 25^\circ C$ unless otherwise noted)

Symbol	Parameter	Max.	Units
$V_{DSS}$	Drain-Source Voltage	60	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current	$T_C = 25^\circ C$	A
		$T_C = 100^\circ C$	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>	168	A
EAS	Single Pulsed Avalanche Energy <sup>note2</sup>	280	mJ
$P_D$	Power Dissipation	$T_C = 25^\circ C$	W
$R_{eJC}$	Thermal Resistance, Junction to Case	1.9	$^\circ C/W$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +175	$^\circ C$
<b>Thermal Characteristic</b>			
Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>		$R_{eJC}$	$1.88$ $^\circ C/W$

**Electrical Characteristics ( $T_c=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	60	-	-	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=60\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b> <sup>(Note 3)</sup>						
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	1	1.6	3	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=30\text{A}$	-	9.8	13	$\text{m}\Omega$
Forward Transconductance	$\text{g}_{\text{FS}}$	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=30\text{A}$	30	-	-	S
<b>Dynamic Characteristics</b> <sup>(Note 4)</sup>						
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=25\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $F=1.0\text{MHz}$	-	1880	-	PF
Output Capacitance	$\text{C}_{\text{oss}}$		-	185	-	PF
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	80	-	PF
<b>Switching Characteristics</b> <sup>(Note 4)</sup>						
Turn-on Delay Time	$t_{\text{d(on)}}$	$\text{V}_{\text{DD}}=30\text{V}, \text{I}_D=2\text{A}, \text{R}_L=1\Omega$ $\text{V}_{\text{GS}}=10\text{V}, \text{R}_{\text{GEN}}=3\Omega$	-	12	-	nS
Turn-on Rise Time	$t_r$		-	5.2	-	nS
Turn-Off Delay Time	$t_{\text{d(off)}}$		-	38	-	nS
Turn-Off Fall Time	$t_f$		-	27	-	nS
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=30\text{V}, \text{I}_D=30\text{A},$ $\text{V}_{\text{GS}}=10\text{V}$	-	36	-	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		-	9.9	-	nC
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		-	6.6	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <sup>(Note 3)</sup>	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=30\text{A}$	-	-	1.2	V
Diode Forward Current <sup>(Note 2)</sup>	$\text{I}_s$		-	-	58	A
Reverse Recovery Time	$t_{\text{rr}}$	$\text{T}_J = 25^\circ\text{C}, \text{IF} = 30\text{A}$ $\text{di/dt} = 100\text{A}/\mu\text{s}$ <sup>(Note 3)</sup>	-	35	-	nS
Reverse Recovery Charge	$\text{Q}_{\text{rr}}$		-	47	-	nC
Forward Turn-On Time	$t_{\text{on}}$	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

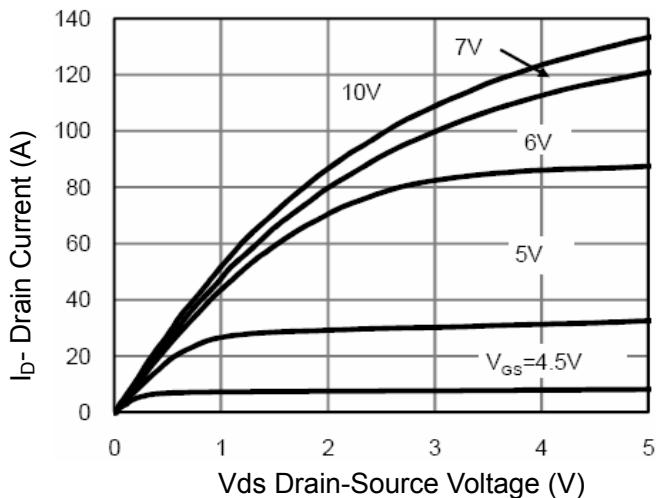
**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
  2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
  3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
  4. Guaranteed by design, not subject to production
5. E<sub>AS</sub> condition:  $\text{T}_J=25^\circ\text{C}, \text{V}_{\text{DD}}=30\text{V}, \text{V}_{\text{G}}=10\text{V}, \text{L}=0.5\text{mH}, \text{R}_g=25\Omega$

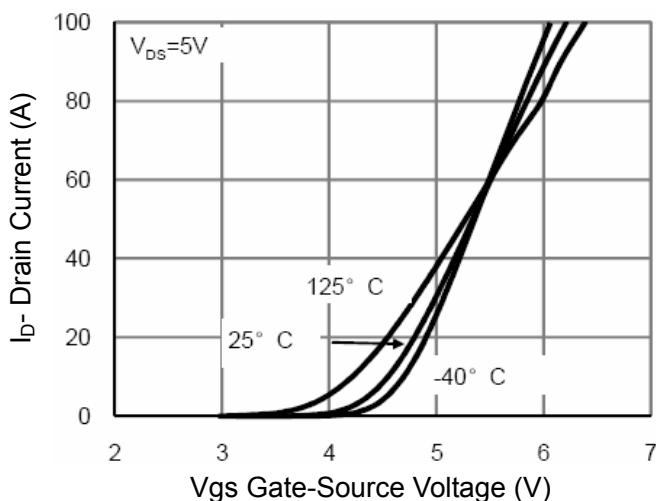
**TM60N06AD**

**N-Channel Enhancement Mosfet**

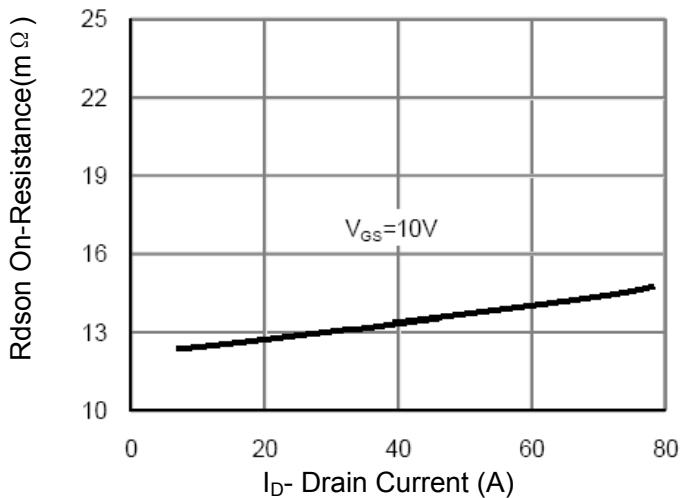
**Typical Performance Characteristics**



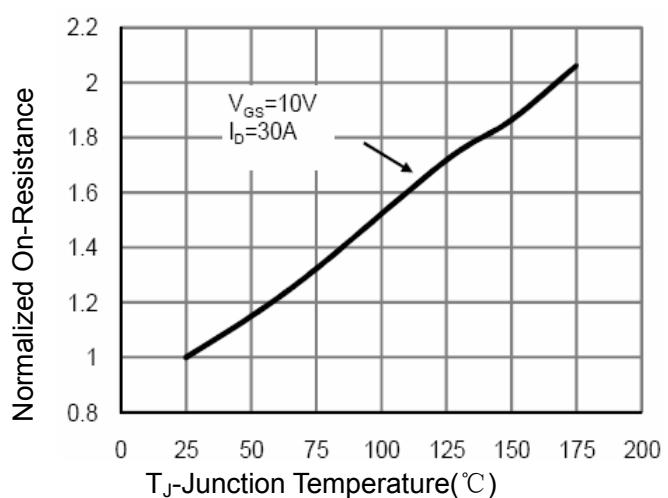
**Figure 1 Output Characteristics**



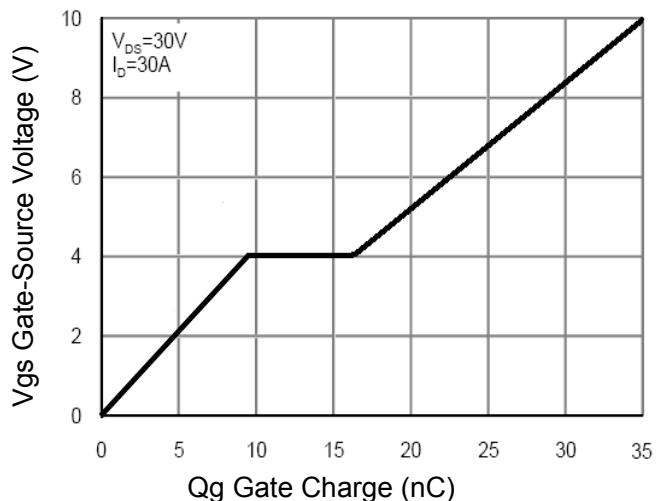
**Figure 2 Transfer Characteristics**



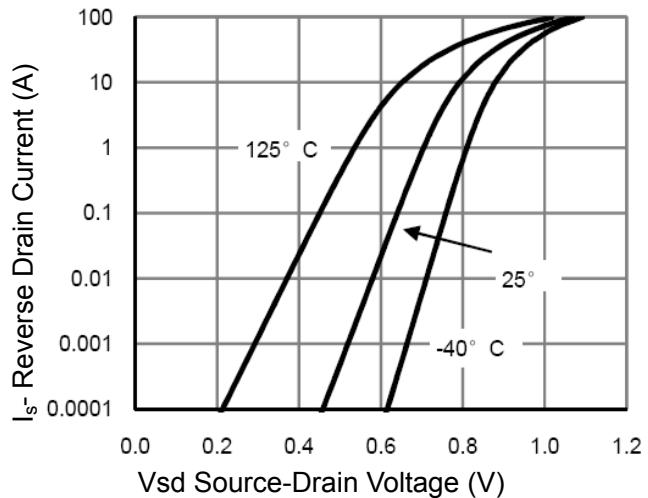
**Figure 3 Rdson- Drain Current**



**Figure 4 Rdson-JunctionTemperature**



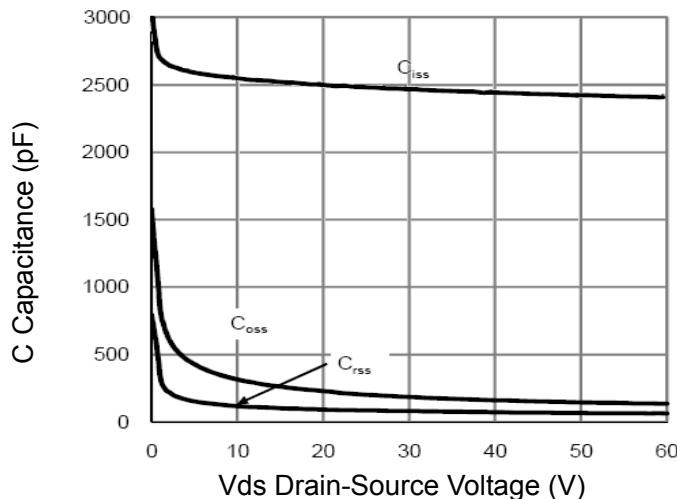
**Figure 5 Gate Charge**



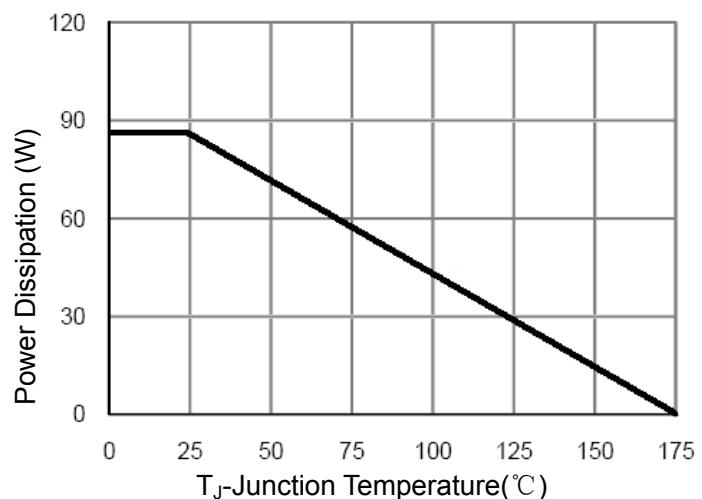
**Figure 6 Source- Drain Diode Forward**

**TM60N06AD**

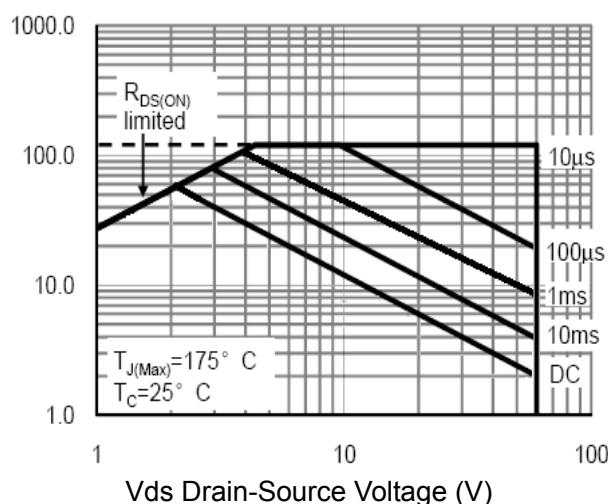
**N-Channel Enhancement Mosfet**



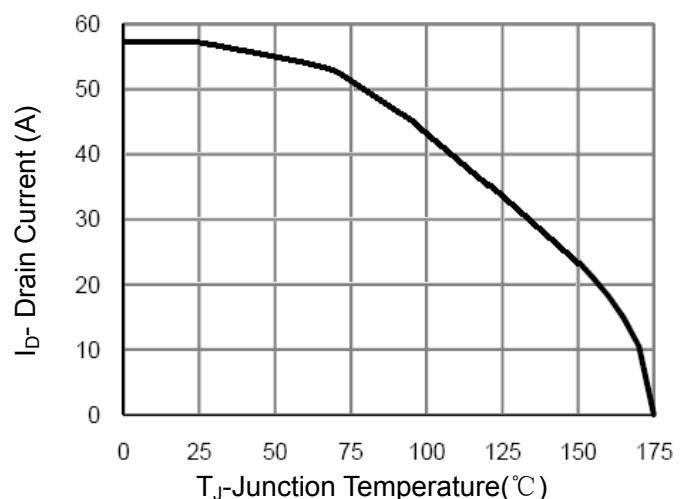
**Figure 7 Capacitance vs Vds**



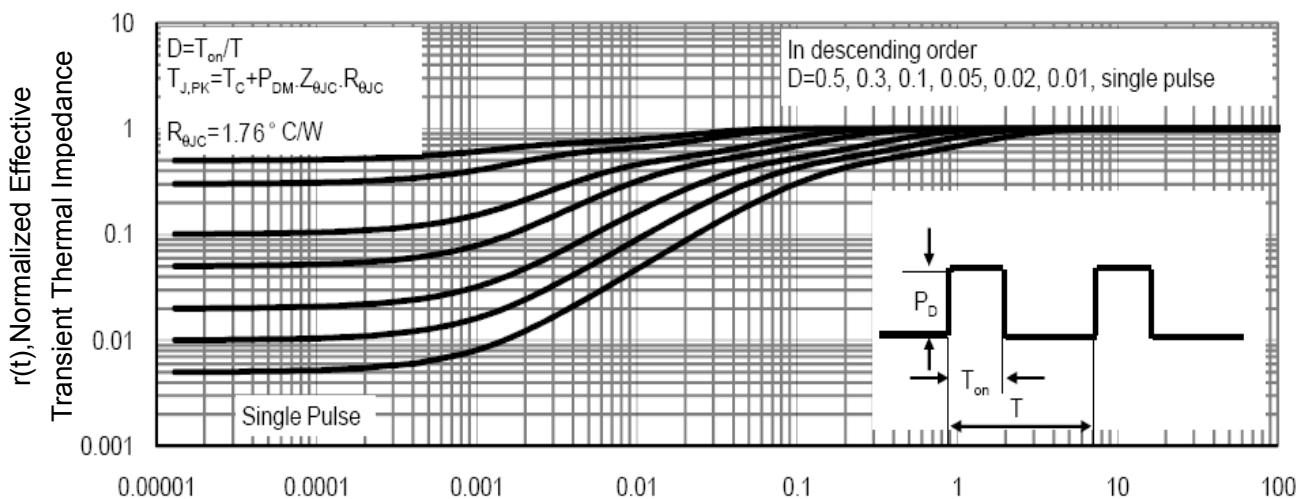
**Figure 9 Power De-rating**



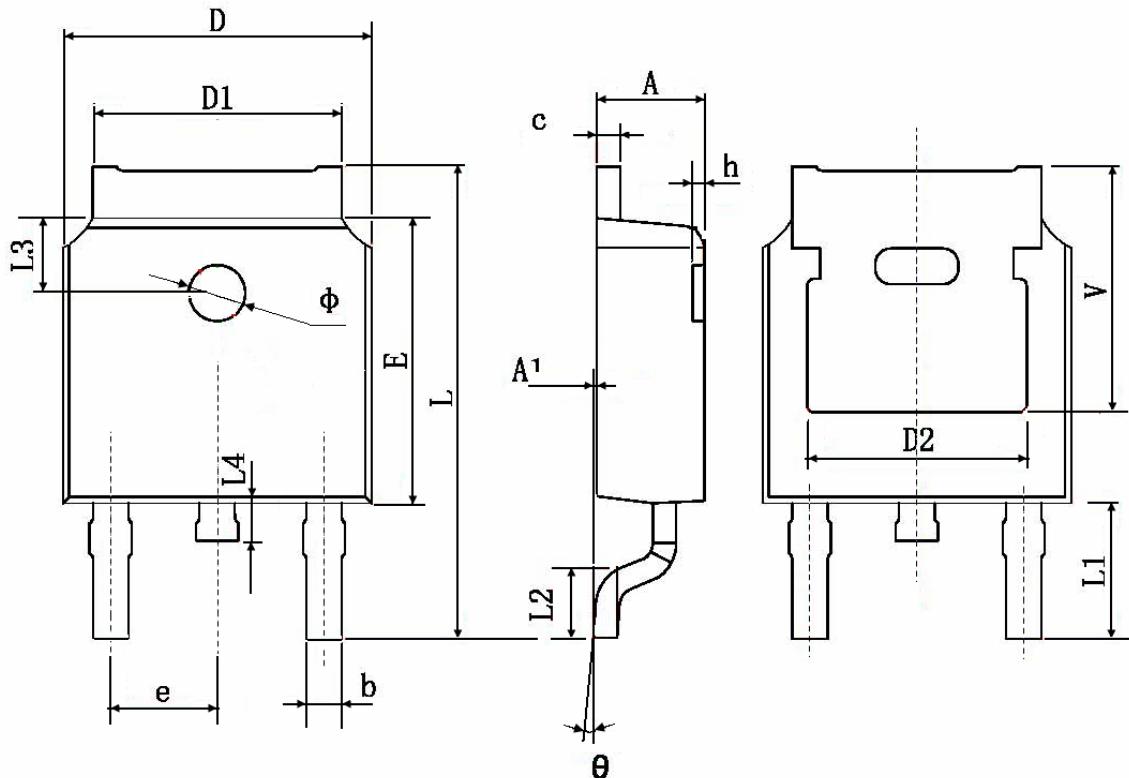
**Figure 8 Safe Operation Area**



**Figure 10 ID Current- JunctionTemperature**



## Package Information: TO-252-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	